



US00D813273S

(12) **United States Design Patent** (10) **Patent No.:** **US D813,273 S**
Mecchella et al. (45) **Date of Patent:** **** Mar. 20, 2018**

(54) **DEVICE COVER**

(71) Applicant: **Amazon Technologies, Inc.**, Seattle, WA (US)
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(73) Assignee: **Amazon Technologies, Inc.**, Seattle, WA (US)
(**) Term: **15 Years**
(21) Appl. No.: **29/578,317**
(22) Filed: **Sep. 20, 2016**
(51) **LOC (11) Cl.** **14-03**
(52) **U.S. Cl.**
USPC **D14/511**; D14/496; D14/203.6
(58) **Field of Classification Search**
USPC D14/496, 356, 432, 511, 203, 0.3, 203.6, D14/217, 216, 238.1, 440, 447; D21/324,
(Continued)

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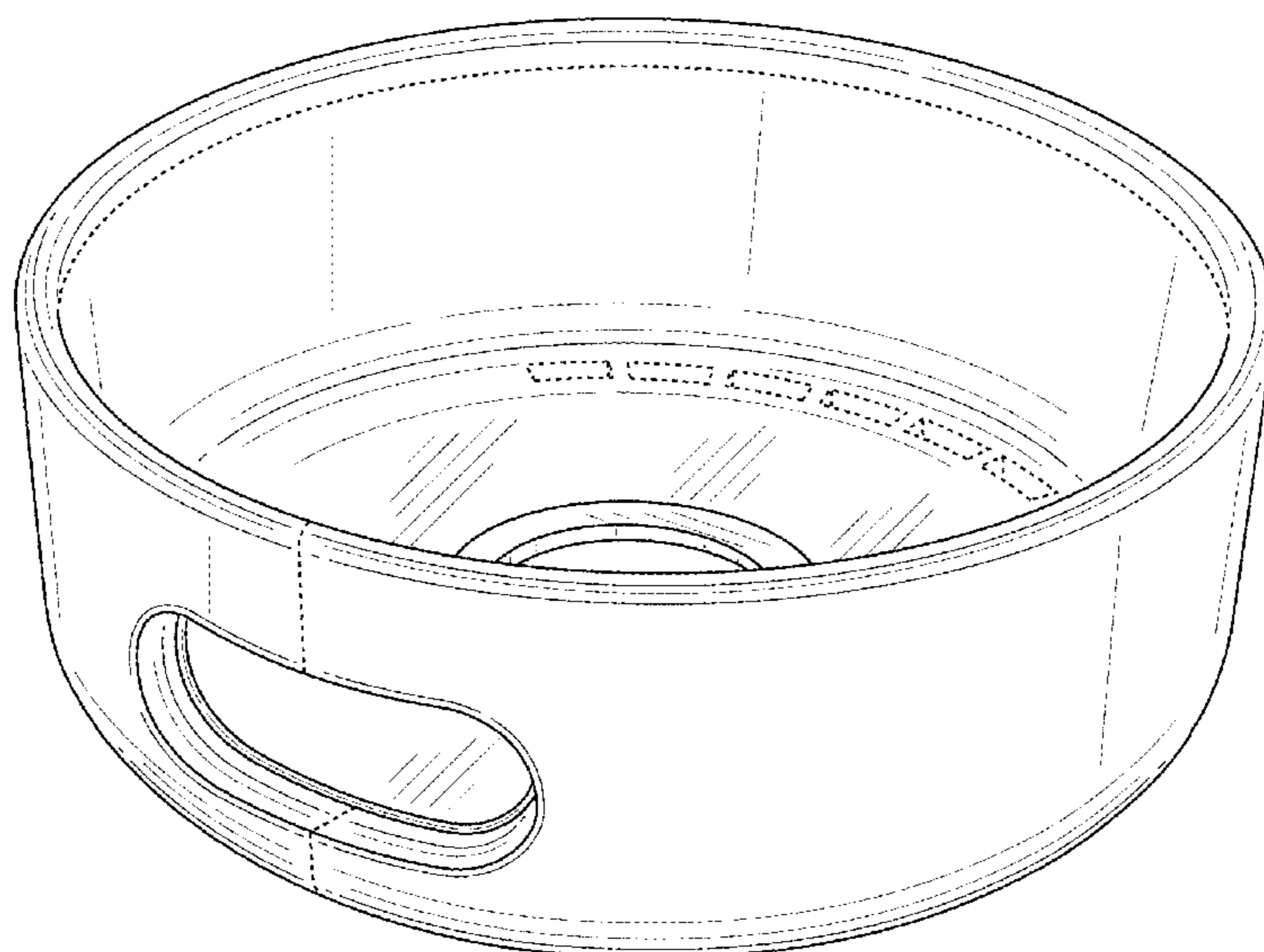
(57) **CLAIM**

The ornamental design for a device cover, as shown and described.

DESCRIPTION

FIG. 1 is a first perspective view of a first embodiment-of a device cover, taken from above.
FIG. 2 is a second perspective view of the first embodiment of the device cover, taken from below.
FIG. 3 is a top view of the first embodiment of the device cover of FIG. 1.
FIG. 4 is a bottom view of the first embodiment of the device cover of FIG. 1.
FIG. 5 is a back view of the first embodiment of the device cover of FIG. 1.
FIG. 6 is a front view of the first embodiment of the device cover of FIG. 1.
FIG. 7 is a left-side view of the first embodiment of the device cover of FIG. 1.
FIG. 8 is a right-side view of the first embodiment of the device cover of FIG. 1.
FIG. 9 is a first perspective view of a second embodiment of a device cover, taken from above. The crosshatched pattern shown on the views of the second embodiment is meant to represent fabric (e.g., a woven fabric), and is understood to be distributed uniformly over the surface of the claimed design upon which the pattern occurs.
FIG. 10 is a second perspective view of the second embodiment of the device cover, taken from below.
FIG. 11 is a top view of the second embodiment of the device cover of FIG. 9.
FIG. 12 is a bottom view of the second embodiment of the device cover of FIG. 9.
FIG. 13 is a back view of the second embodiment of the device cover of FIG. 9.
FIG. 14 is a front view of the second embodiment of the device cover of FIG. 9.
FIG. 15 is a left-side view of the second embodiment of the device cover of FIG. 9; and,
FIG. 16 is a right-side view of the second embodiment of the device cover of FIG. 9.
The broken lines represent features of the device cover which form no part of the claimed design.

1 Claim, 16 Drawing Sheets



(58) **Field of Classification Search**

USPC D21/328, 333; D8/330, 343, 346;
273/148 B; 463/1, 29-36, 46, 47

CPC G06F 1/1628; G06F 1/1613; G06F 1/1626;
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See application file for complete search history.

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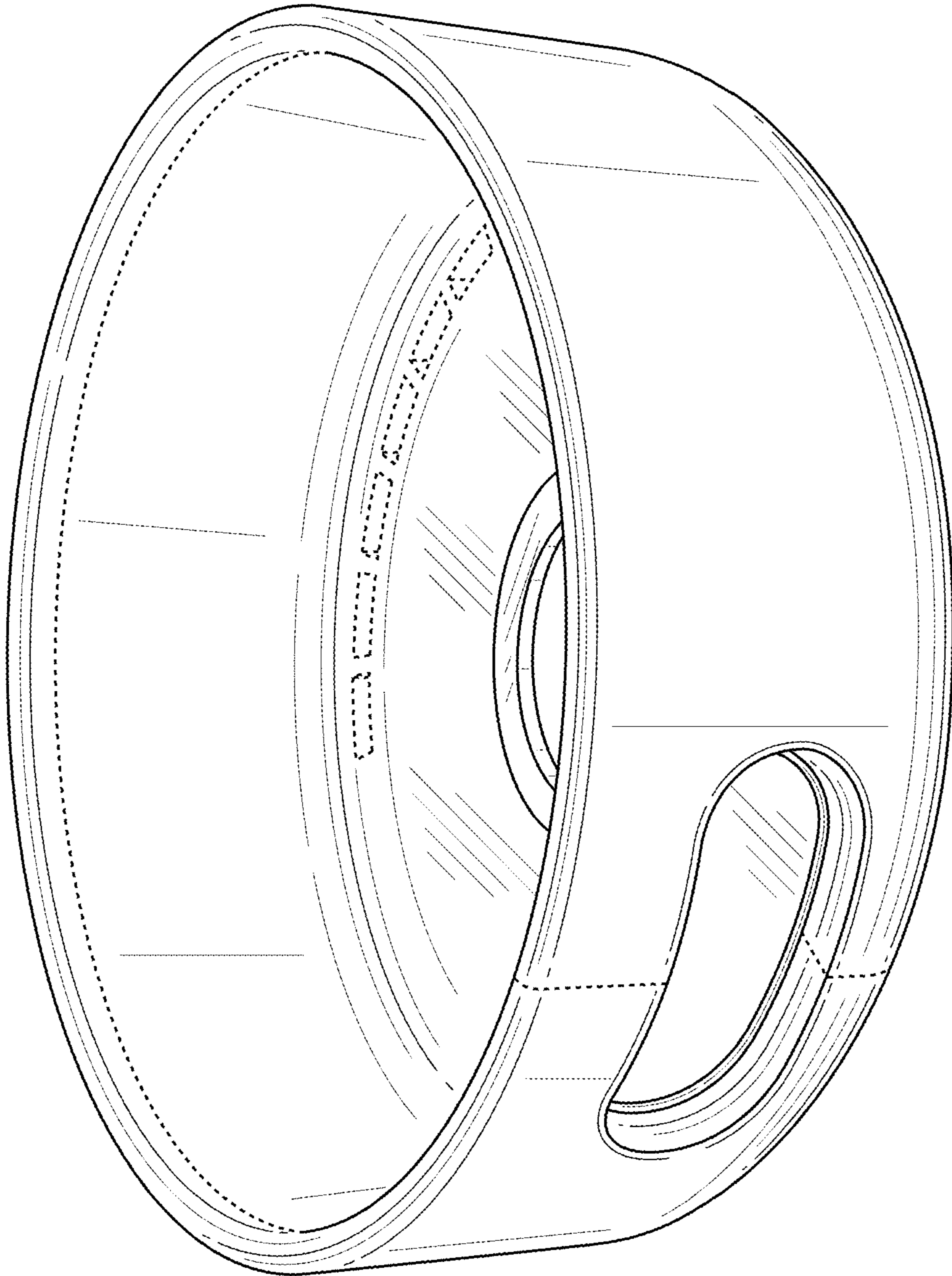


FIG. 1

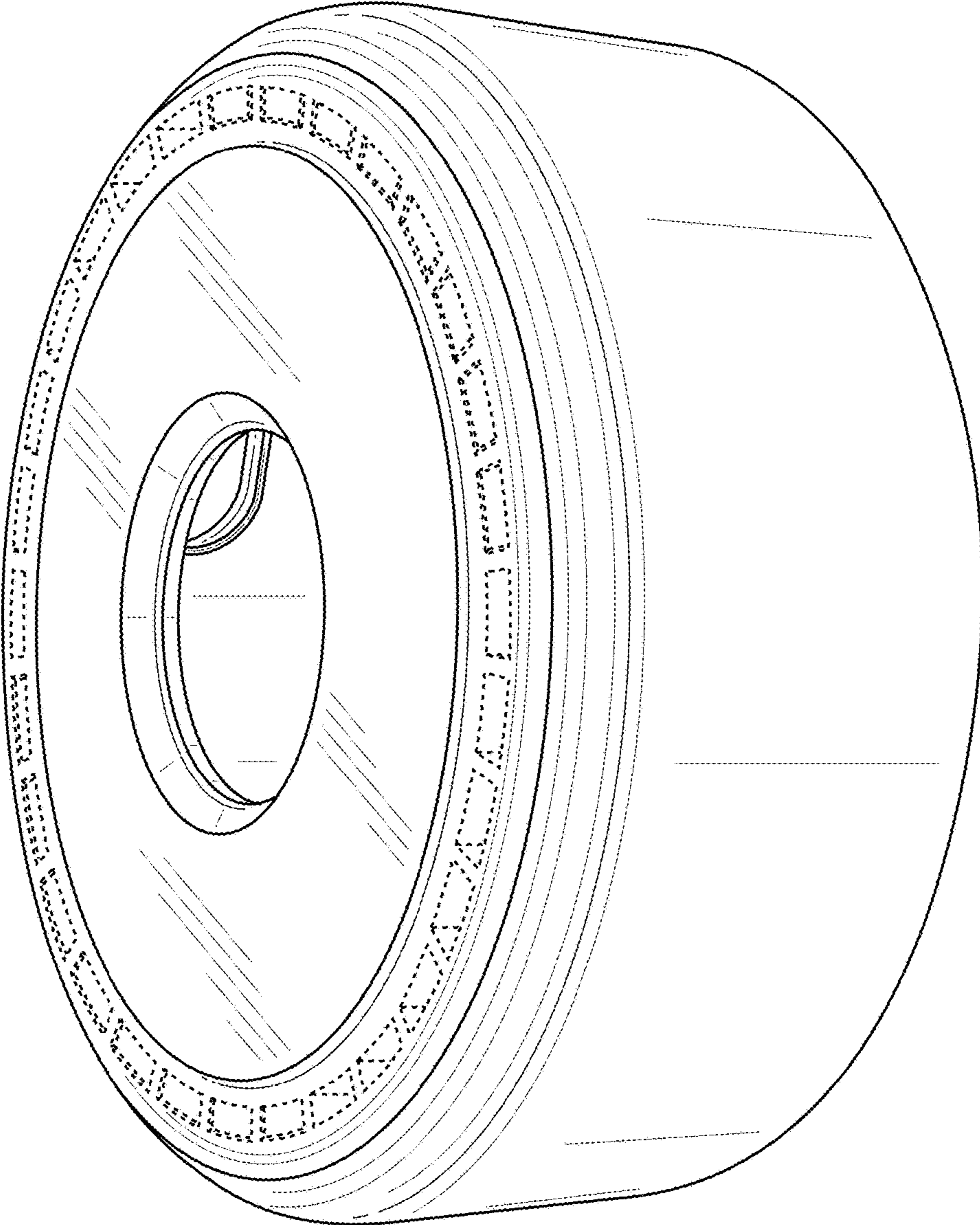


FIG. 2

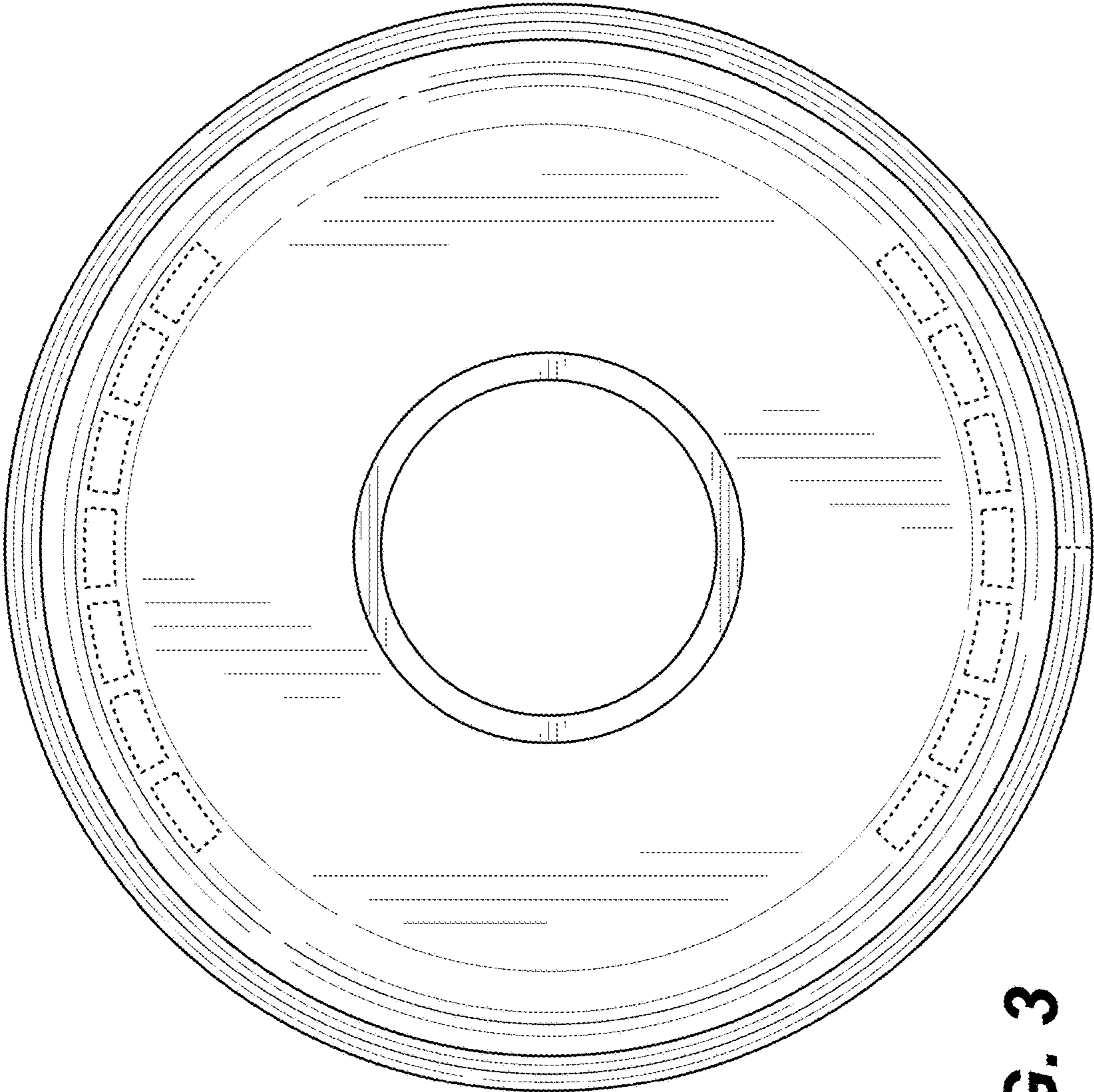


FIG. 3

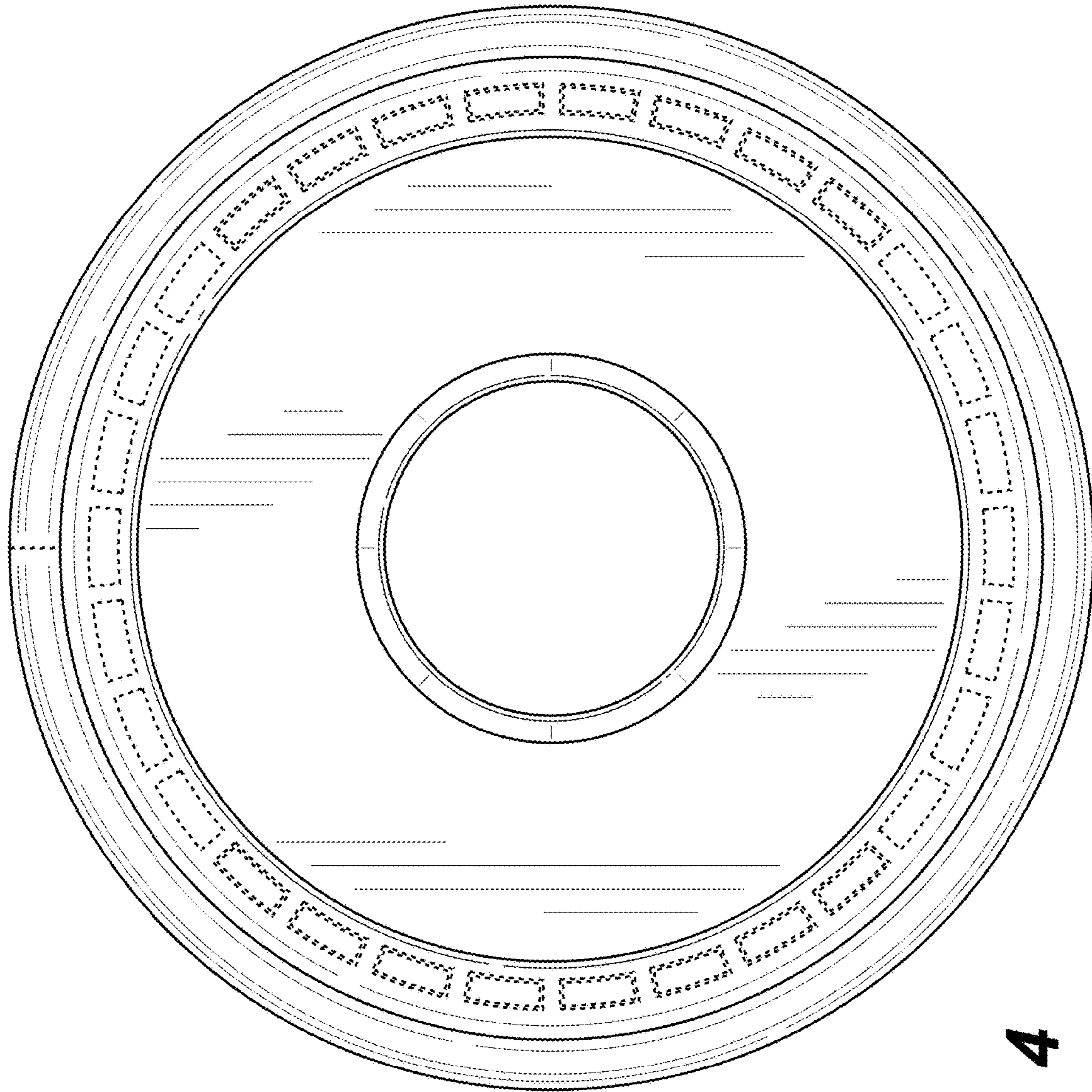


FIG. 4

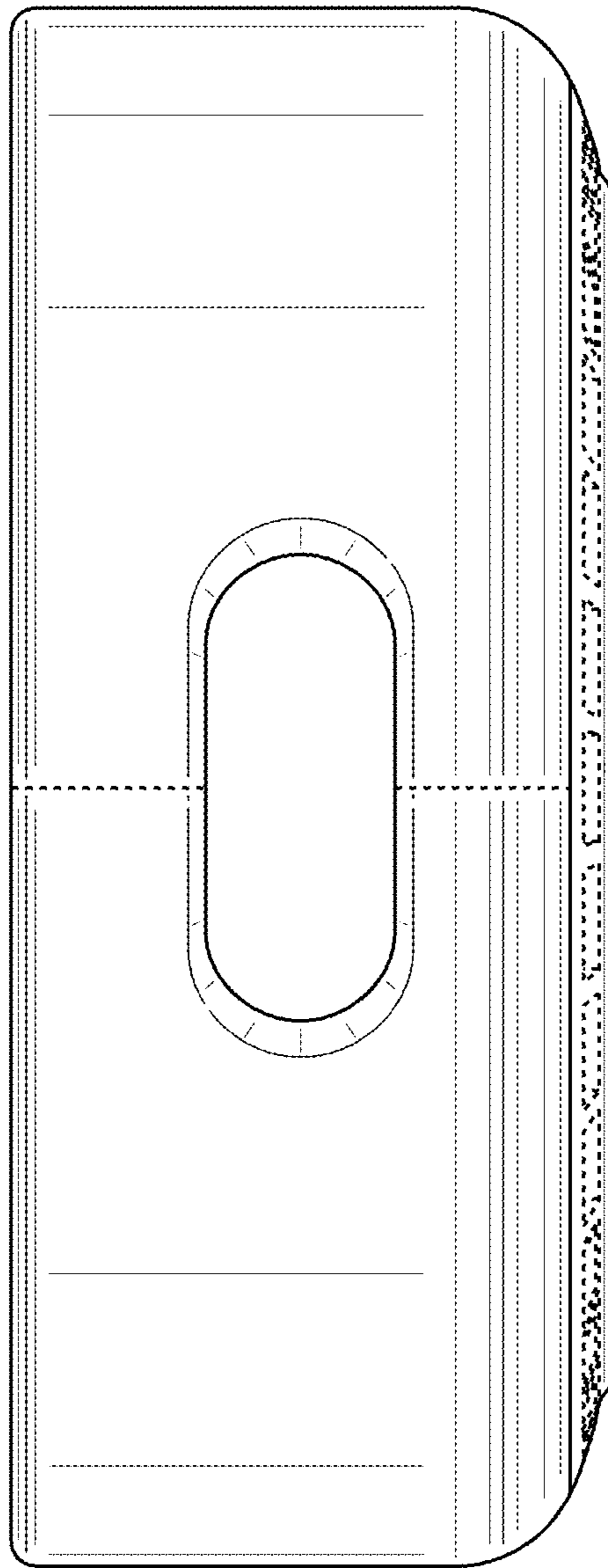


FIG. 5

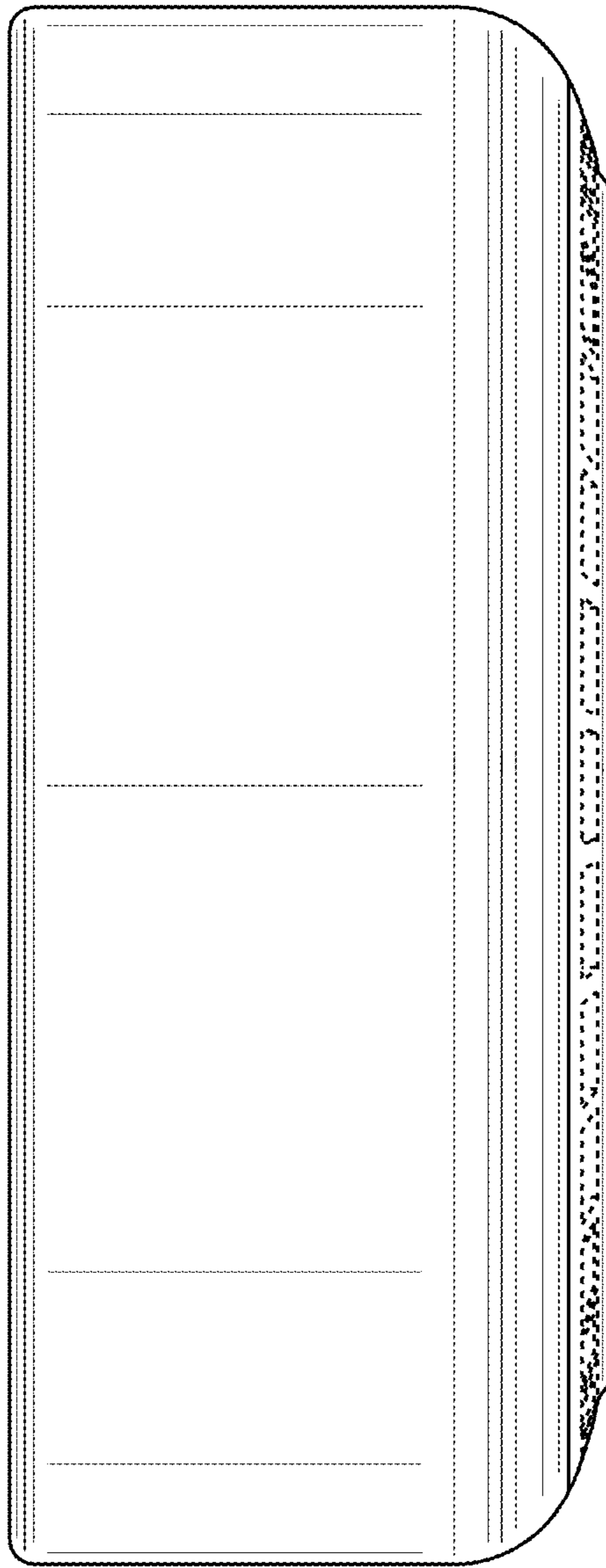


FIG. 6

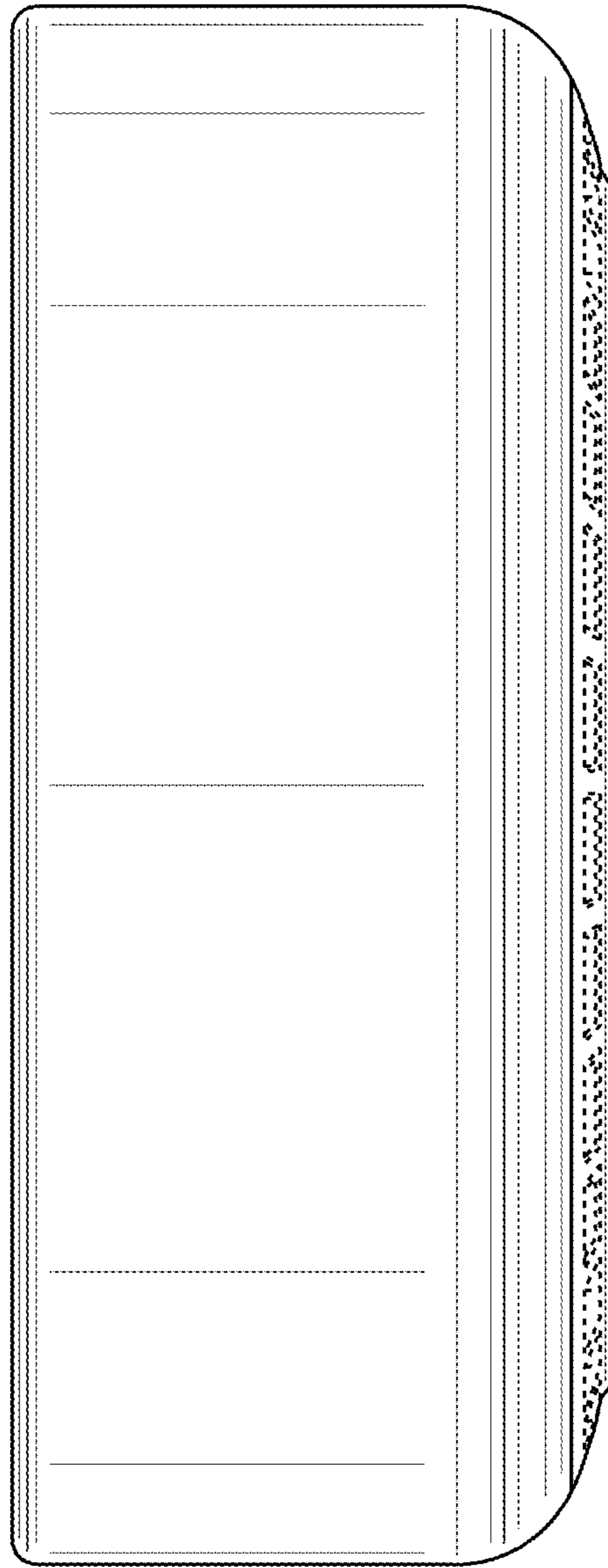


FIG. 7

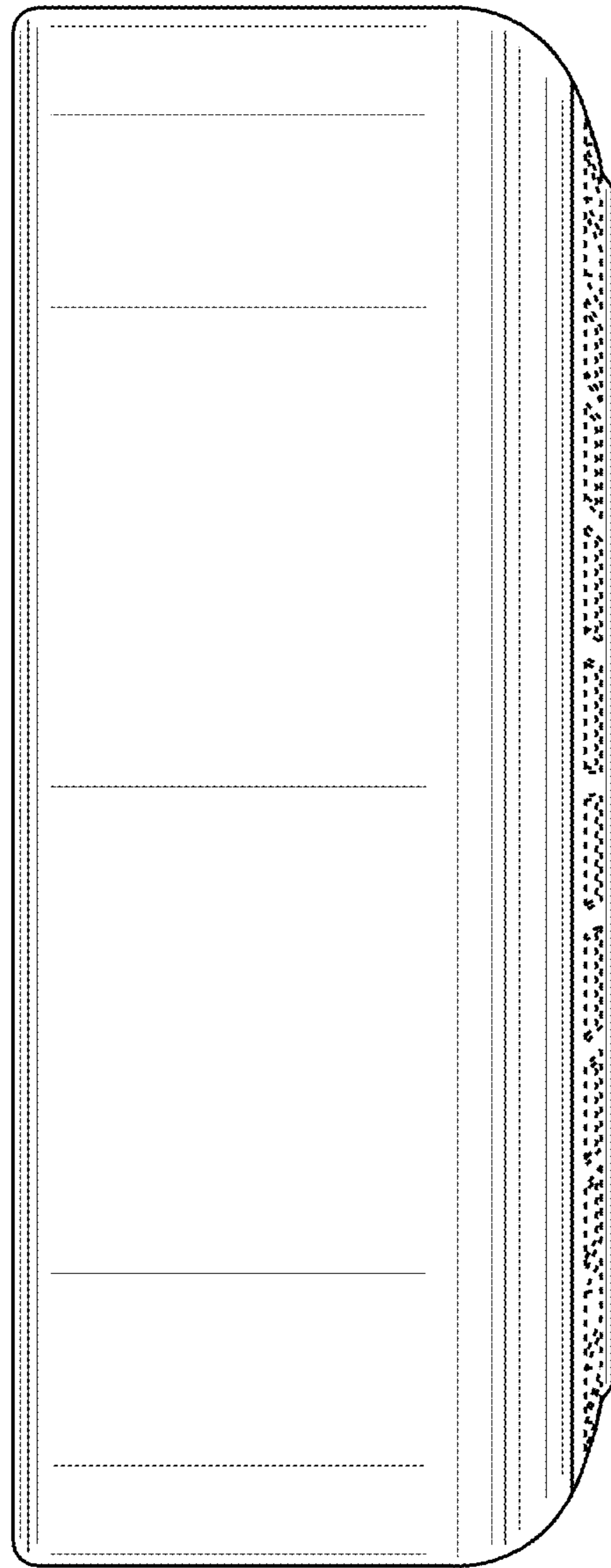


FIG. 8

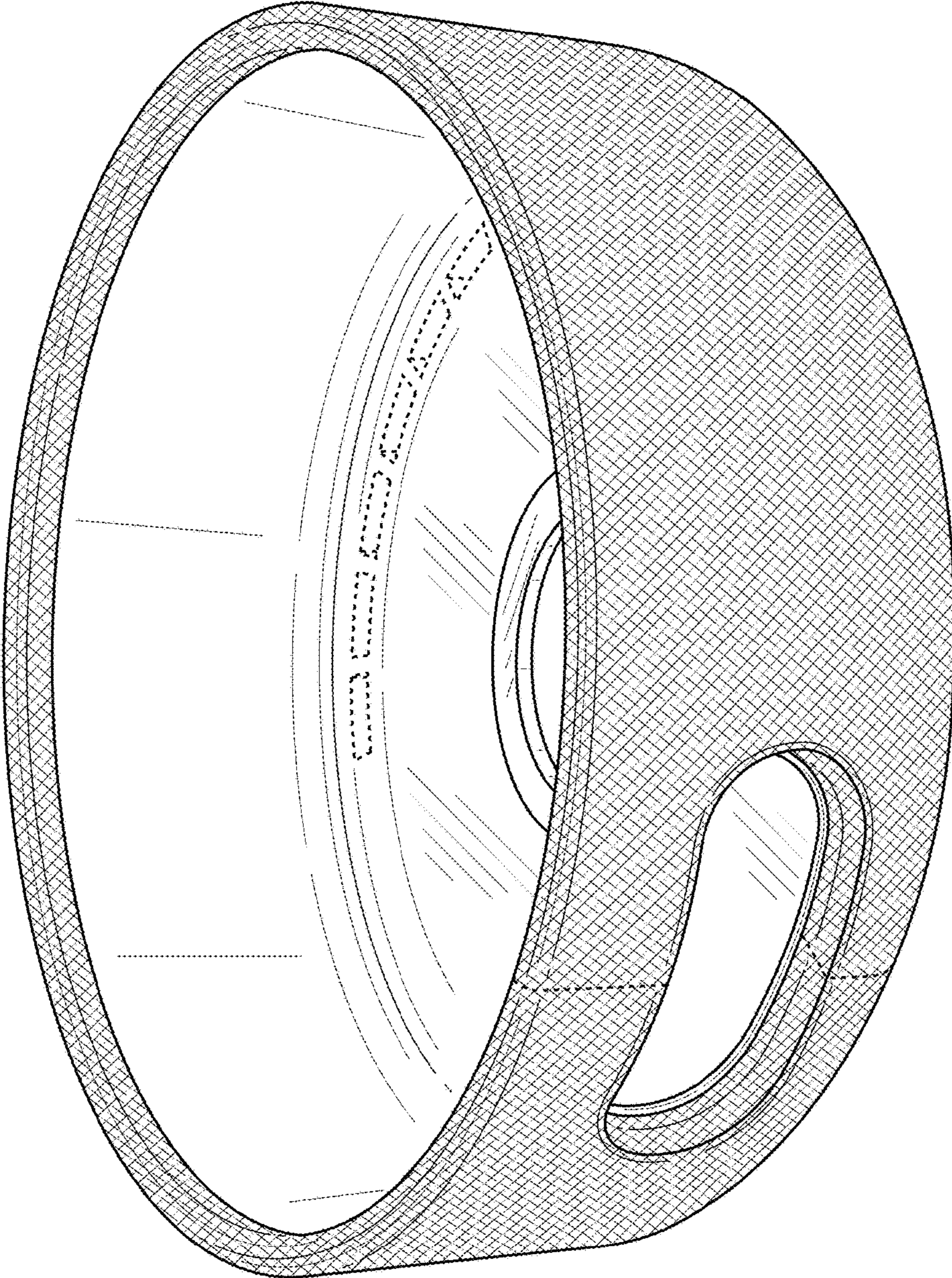


FIG. 9

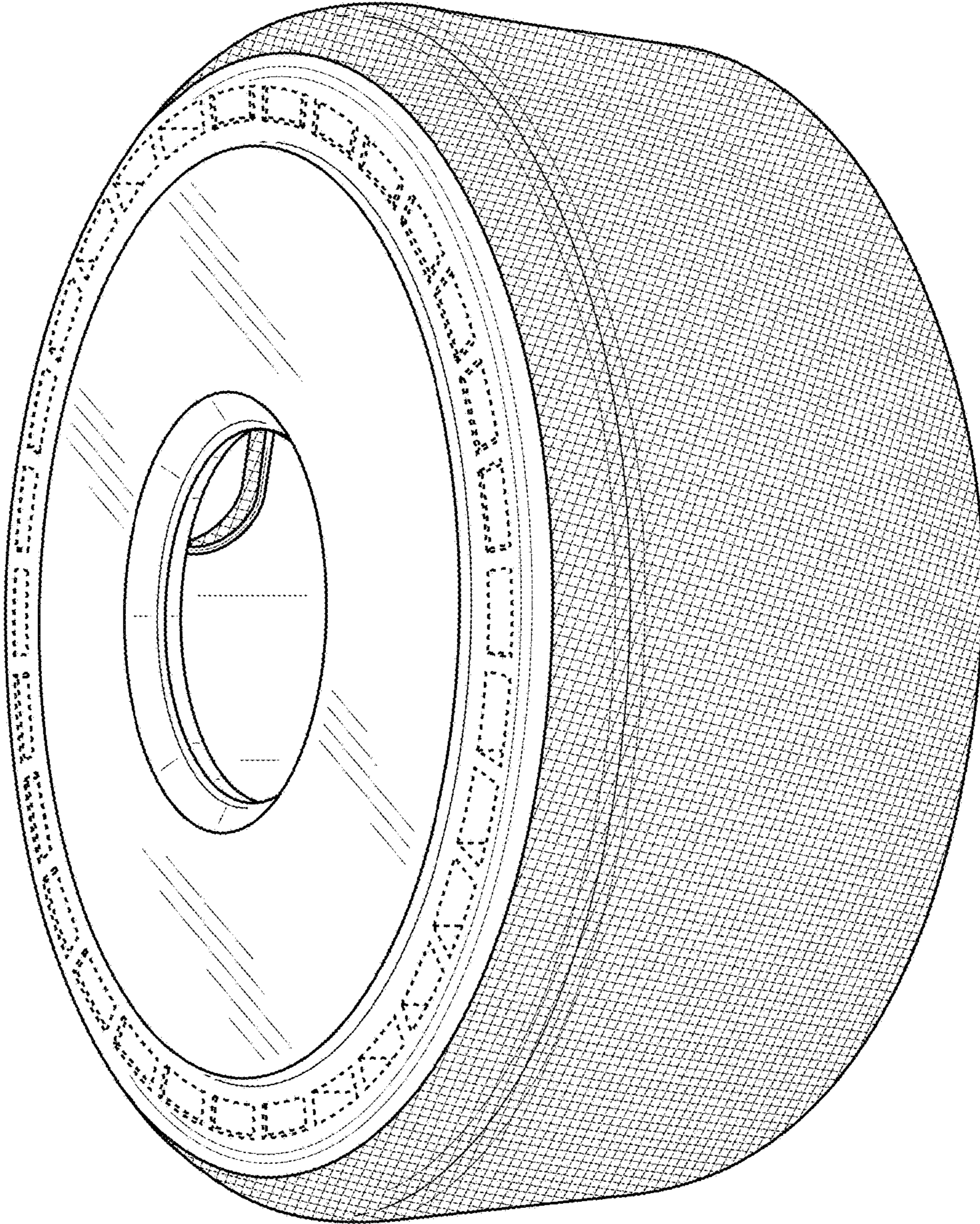


FIG. 10

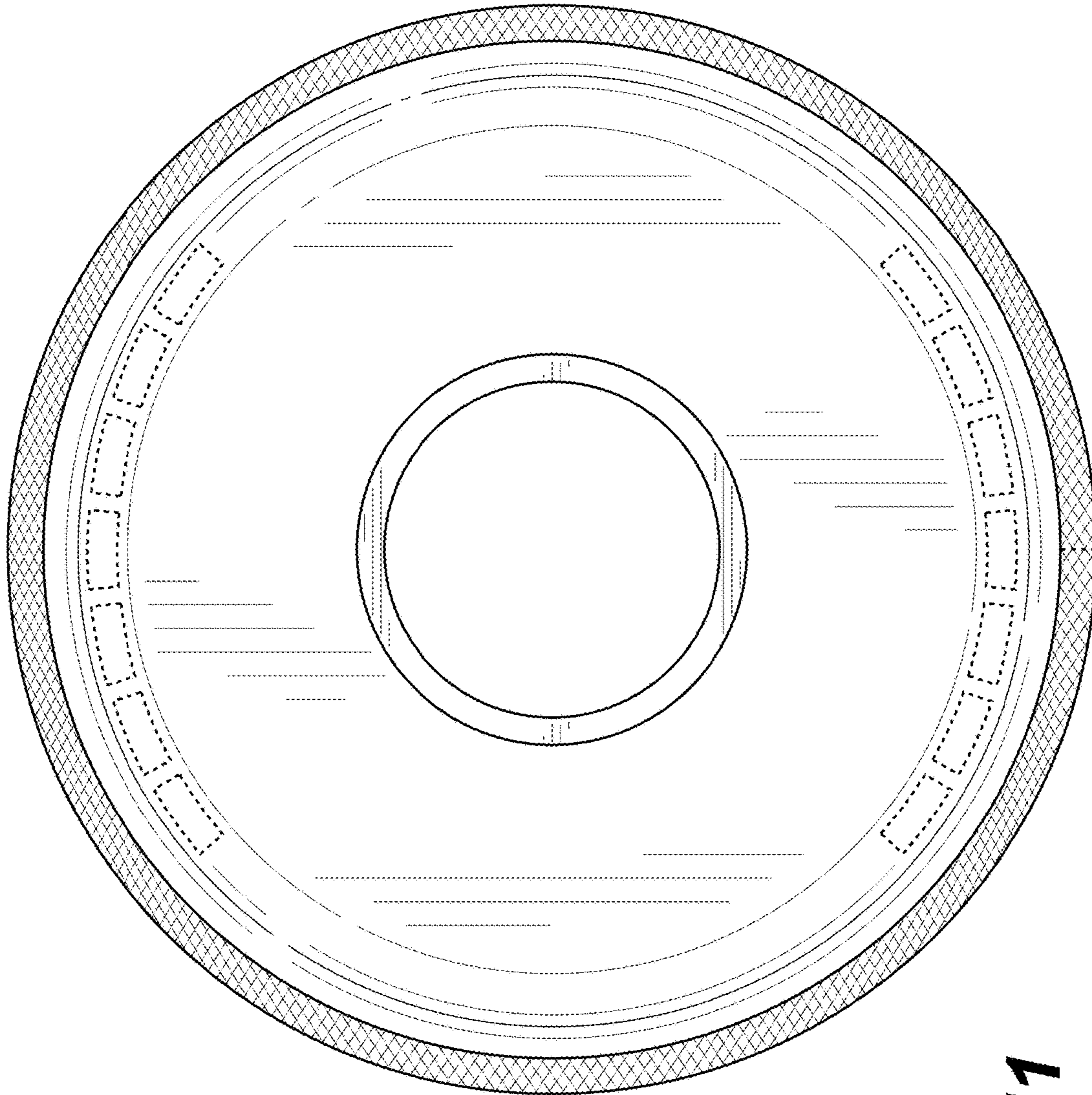


FIG. 11

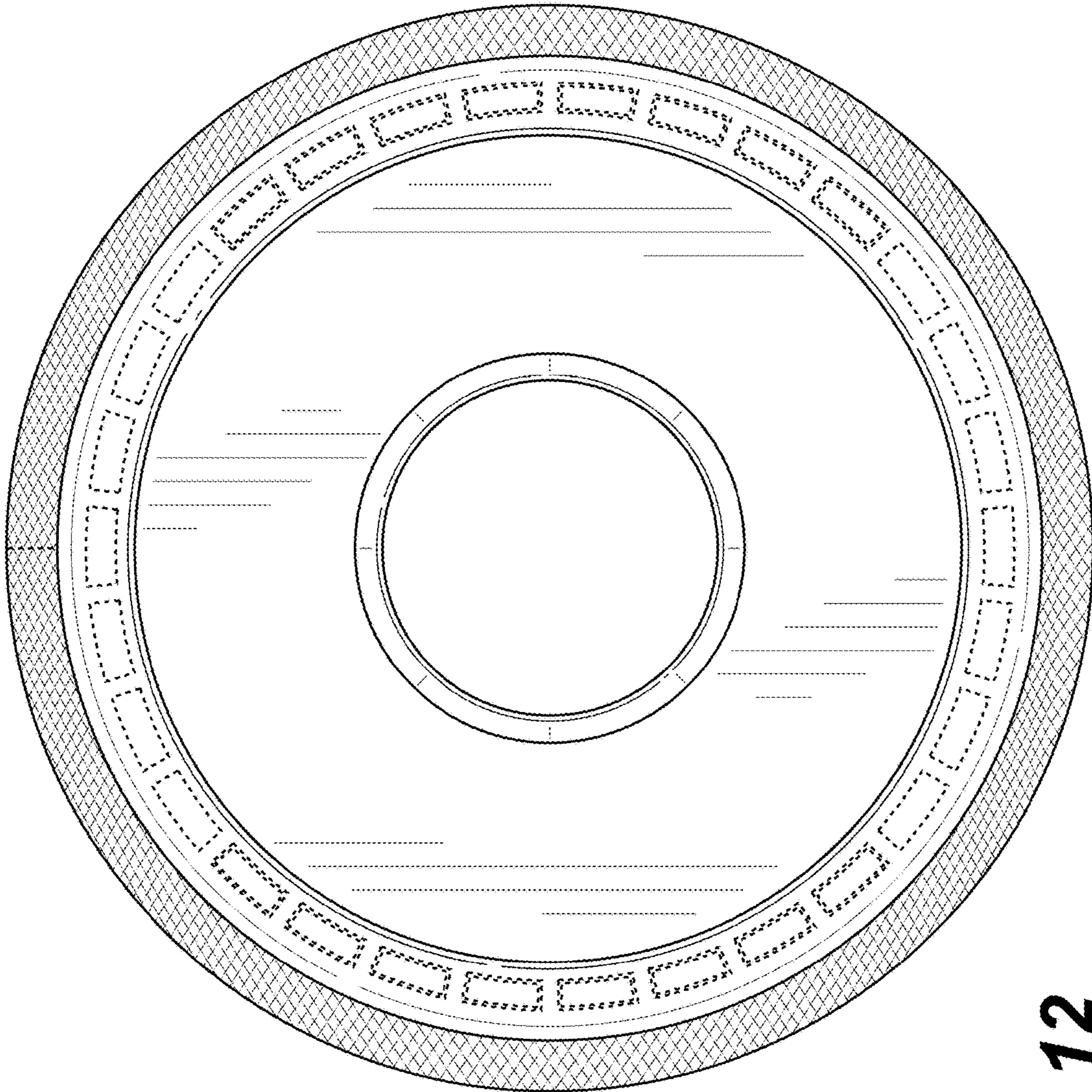


FIG. 12

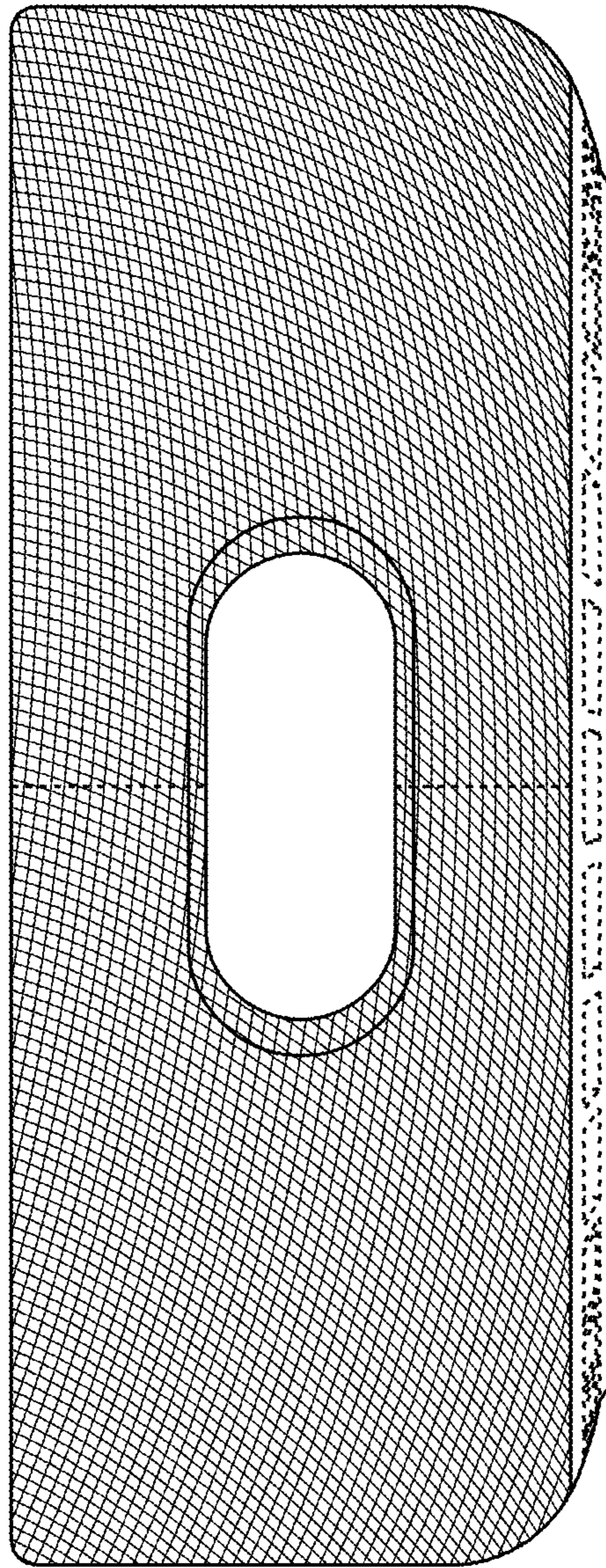


FIG. 13

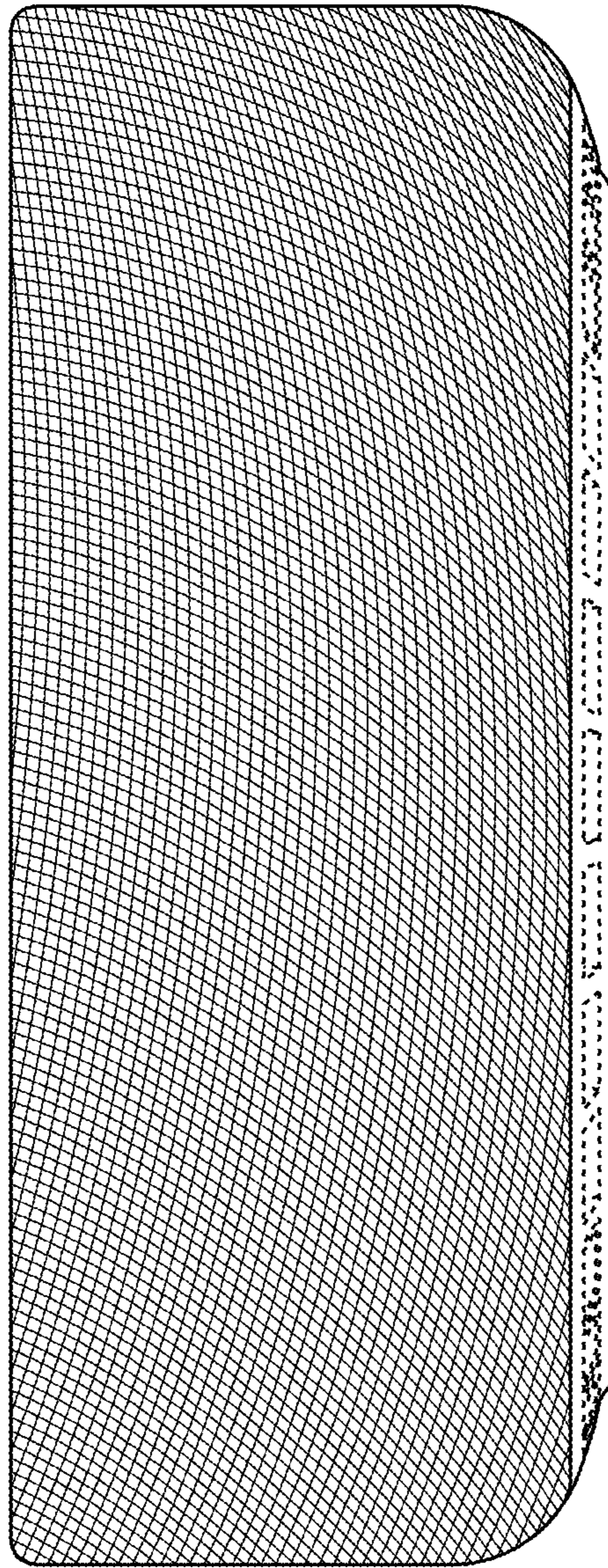


FIG. 14

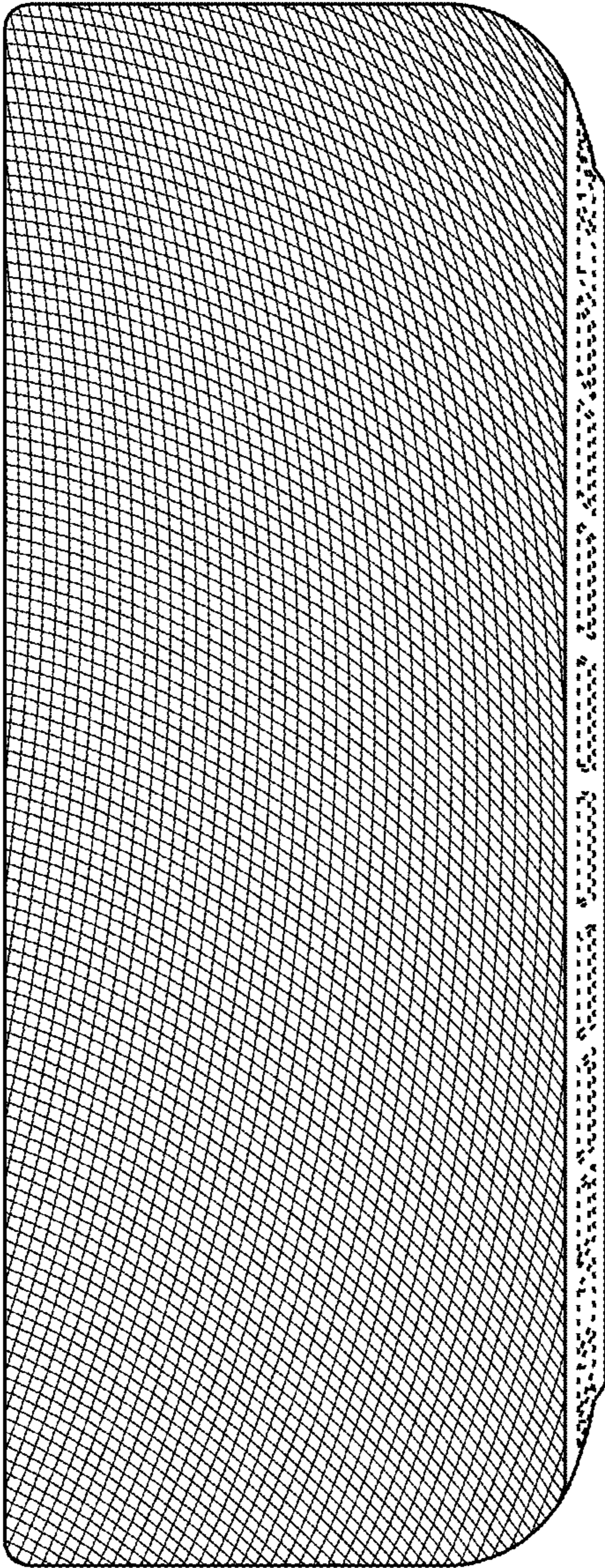


FIG. 15

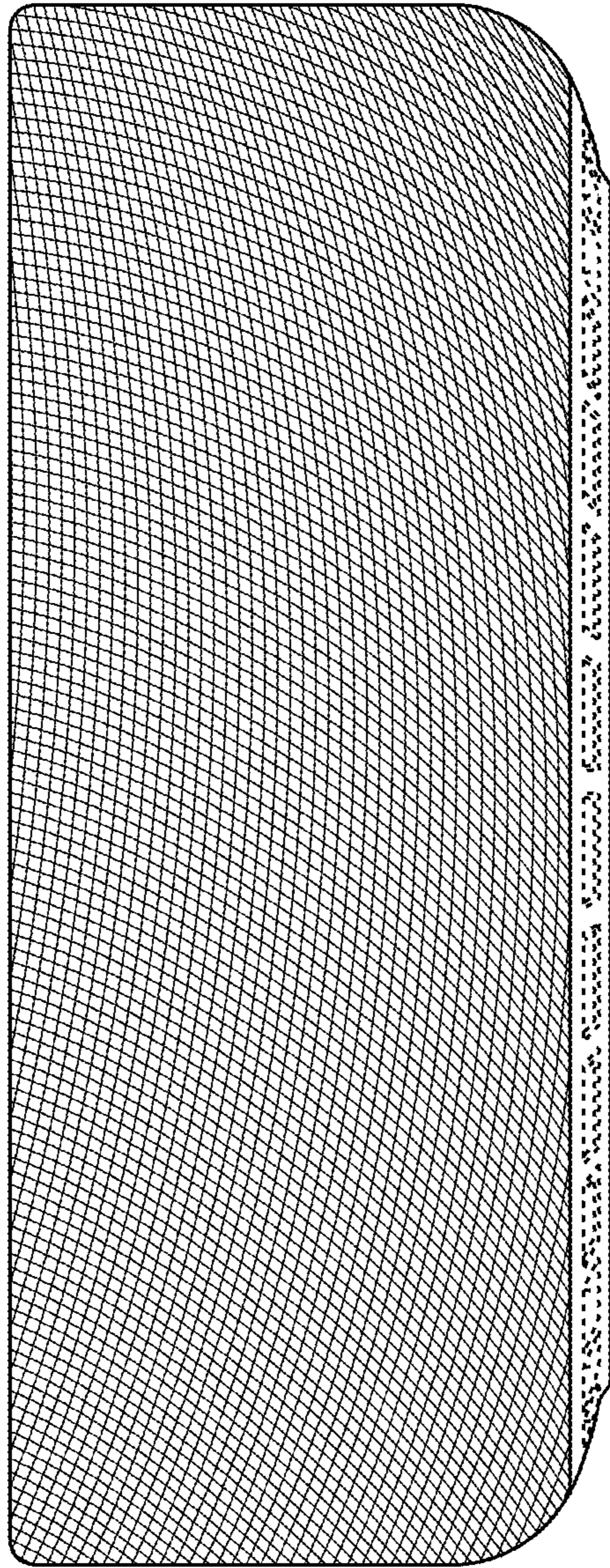


FIG. 16